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### **Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems**

**Embedded - System On Chip (SoC)** refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

### **What are Embedded - System On Chip (SoC)?**

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

#### **Details**

|                         |   |
|-------------------------|---|
| Product Status          | Active  |
| Architecture            | MCU, FPGA   |
| Core Processor          | Dual ARM® Cortex®-A9 MPCore™ with CoreSight™  |
| Flash Size              | -   |
| RAM Size                | 256KB   |
| Peripherals             | DMA, POR, WDT   |
| Connectivity            | EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG  |
| Speed                   | 1.5GHz  |
| Primary Attributes      | FPGA - 480K Logic Elements  |
| Operating Temperature   | 0°C ~ 100°C (TJ)  |
| Package / Case          | 780-BBGA, FCBGA   |
| Supplier Device Package | 780-FBGA, FC (29x29)  |
| Purchase URL            | <a href="https://www.e-xfl.com/product-detail/intel/10as048e1f29e1hg">https://www.e-xfl.com/product-detail/intel/10as048e1f29e1hg</a> |



## Key Advantages of Intel Arria 10 Devices

**Table 2. Key Advantages of the Intel Arria 10 Device Family**

| Advantage  | Supporting Feature  |
|--|---|
| Enhanced core architecture   | <ul style="list-style-type: none"><li>Built on TSMC's 20 nm process technology</li><li>60% higher performance than the previous generation of mid-range FPGAs</li><li>15% higher performance than the fastest previous-generation FPGA</li></ul>  |
| High-bandwidth integrated transceivers   | <ul style="list-style-type: none"><li>Short-reach rates up to 25.8 Gigabits per second (Gbps)</li><li>Backplane capability up to 12.5 Gbps</li><li>Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC)</li></ul>   |
| Improved logic integration and hard IP blocks  | <ul style="list-style-type: none"><li>8-input adaptive logic module (ALM)</li><li>Up to 65.6 megabits (Mb) of embedded memory</li><li>Variable-precision digital signal processing (DSP) blocks</li><li>Fractional synthesis phase-locked loops (PLLs)</li><li>Hard PCI Express Gen3 IP blocks</li><li>Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps)</li></ul> |
| Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor | <ul style="list-style-type: none"><li>Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC)</li><li>Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric</li></ul>  |
| Advanced power savings   | <ul style="list-style-type: none"><li>Comprehensive set of advanced power saving features</li><li>Power-optimized MultiTrack routing and core architecture</li><li>Up to 40% lower power compared to previous generation of mid-range FPGAs</li><li>Up to 60% lower power compared to previous generation of high-end FPGAs</li></ul>   |

## Summary of Intel Arria 10 Features

**Table 3. Summary of Features for Intel Arria 10 Devices**

| Feature                      | Description   |
|------------------------------|---|
| Technology                   | <ul style="list-style-type: none"><li>TSMC's 20-nm SoC process technology</li><li>Allows operation at a lower <math>V_{CC}</math> level of 0.82 V instead of the 0.9 V standard <math>V_{CC}</math> core voltage</li></ul>  |
| Packaging                    | <ul style="list-style-type: none"><li>1.0 mm ball-pitch FINELINE BGA packaging</li><li>0.8 mm ball-pitch Ultra FINELINE BGA packaging</li><li>Multiple devices with identical package footprints for seamless migration between different FPGA densities</li><li>Devices with compatible package footprints allow migration to next generation high-end Stratix® 10 devices</li><li>RoHS, leaded<sup>(1)</sup>, and lead-free (Pb-free) options</li></ul> |
| High-performance FPGA fabric | <ul style="list-style-type: none"><li>Enhanced 8-input ALM with four registers</li><li>Improved multi-track routing architecture to reduce congestion and improve compilation time</li><li>Hierarchical core clocking architecture</li><li>Fine-grained partial reconfiguration</li></ul>   |
| Internal memory blocks       | <ul style="list-style-type: none"><li>M20K—20-Kb memory blocks with hard error correction code (ECC)</li><li>Memory logic array block (MLAB)—640-bit memory</li></ul>   |
| continued...                 |   |

<sup>(1)</sup> Contact Intel for availability.



| Feature                                 | Description   |  |
|---|---|--|
| Low-power serial transceivers           | <ul style="list-style-type: none"><li>Continuous operating range:<ul style="list-style-type: none"><li>Intel Arria 10 GX—1 Gbps to 17.4 Gbps</li><li>Intel Arria 10 GT—1 Gbps to 25.8 Gbps</li></ul></li><li>Backplane support:<ul style="list-style-type: none"><li>Intel Arria 10 GX—up to 12.5</li><li>Intel Arria 10 GT—up to 12.5</li></ul></li><li>Extended range down to 125 Mbps with oversampling</li><li>ATX transmit PLLs with user-configurable fractional synthesis capability</li><li>Electronic Dispersion Compensation (EDC) support for XFP, SFP+, QSFP, and CFP optical module</li><li>Adaptive linear and decision feedback equalization</li><li>Transmitter pre-emphasis and de-emphasis</li><li>Dynamic partial reconfiguration of individual transceiver channels</li></ul> |  |
| HPS<br>(Intel Arria 10 SX devices only) | Processor and system  | <ul style="list-style-type: none"><li>Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability</li><li>256 KB on-chip RAM and 64 KB on-chip ROM</li><li>System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers</li><li>Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA)</li><li>ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage</li></ul>   |
|   | External interfaces   | <ul style="list-style-type: none"><li>Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller</li><li>Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-Go (OTG) controllers, I<sup>2</sup>C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os)</li></ul>   |
|   | Interconnects to core   | <ul style="list-style-type: none"><li>High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write</li><li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li><li>Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port</li><li>FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller</li></ul> |
| Configuration                           | <ul style="list-style-type: none"><li>Tamper protection—comprehensive design protection to protect your valuable IP investments</li><li>Enhanced 256-bit advanced encryption standard (AES) design security with authentication</li><li>Configuration via protocol (CvP) using PCIe Gen1, Gen2, or Gen3</li></ul>   |  |
| continued...                            |   |  |

<sup>(2)</sup> Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



| Feature            | Description   |
|--------------------|---|
|                    | <ul style="list-style-type: none"><li>Dynamic reconfiguration of the transceivers and PLLs</li><li>Fine-grained partial reconfiguration of the core fabric</li><li>Active Serial x4 Interface</li></ul>   |
| Power management   | <ul style="list-style-type: none"><li>SmartVID</li><li>Low static power device options</li><li>Programmable Power Technology</li><li>Intel Quartus Prime integrated power analysis</li></ul>  |
| Software and tools | <ul style="list-style-type: none"><li>Intel Quartus Prime design suite</li><li>Transceiver toolkit</li><li>Platform Designer system integration tool</li><li>DSP Builder for Intel FPGAs</li><li>OpenCL™ support</li><li>Intel SoC FPGA Embedded Design Suite (EDS)</li></ul> |

### Related Information

#### [Intel Arria 10 Transceiver PHY Overview](#)

Provides details on Intel Arria 10 transceivers.

## Intel Arria 10 Device Variants and Packages

**Table 4. Device Variants for the Intel Arria 10 Device Family**

| Variant           | Description   |
|-------------------|---|
| Intel Arria 10 GX | FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.  |
| Intel Arria 10 GT | FPGA featuring: <ul style="list-style-type: none"><li>17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.</li><li>25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules.</li></ul> |
| Intel Arria 10 SX | SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.  |

## Intel Arria 10 GX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

### Related Information

#### [Intel FPGA Product Selector](#)

Provides the latest information on Intel products.



## Maximum Resources

**Table 5. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 160, GX 220, GX 270, GX 320, and GX 480)**

| Resource                     |                      | Product Line |         |         |         |         |
|------------------------------|----------------------|--------------|---------|---------|---------|---------|
|                              |                      | GX 160       | GX 220  | GX 270  | GX 320  | GX 480  |
| Logic Elements (LE) (K)      |                      | 160          | 220     | 270     | 320     | 480     |
| ALM                          |                      | 61,510       | 80,330  | 101,620 | 119,900 | 183,590 |
| Register                     |                      | 246,040      | 321,320 | 406,480 | 479,600 | 734,360 |
| Memory (Kb)                  | M20K                 | 8,800        | 11,740  | 15,000  | 17,820  | 28,620  |
|                              | MLAB                 | 1,050        | 1,690   | 2,452   | 2,727   | 4,164   |
| Variable-precision DSP Block |                      | 156          | 192     | 830     | 985     | 1,368   |
| 18 x 19 Multiplier           |                      | 312          | 384     | 1,660   | 1,970   | 2,736   |
| PLL                          | Fractional Synthesis | 6            | 6       | 8       | 8       | 12      |
|                              | I/O                  | 6            | 6       | 8       | 8       | 12      |
| 17.4 Gbps Transceiver        |                      | 12           | 12      | 24      | 24      | 36      |
| GPIO <sup>(3)</sup>          |                      | 288          | 288     | 384     | 384     | 492     |
| LVDS Pair <sup>(4)</sup>     |                      | 120          | 120     | 168     | 168     | 222     |
| PCIe Hard IP Block           |                      | 1            | 1       | 2       | 2       | 2       |
| Hard Memory Controller       |                      | 6            | 6       | 8       | 8       | 12      |

<sup>(3)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(4)</sup> Each LVDS I/O pair can be used as differential input or output.



**Table 6. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)**

| Resource                     |                      | Product Line |           |           |           |
|------------------------------|----------------------|--------------|-----------|-----------|-----------|
|                              |                      | GX 570       | GX 660    | GX 900    | GX 1150   |
| Logic Elements (LE) (K)      |                      | 570          | 660       | 900       | 1,150     |
| ALM                          |                      | 217,080      | 251,680   | 339,620   | 427,200   |
| Register                     |                      | 868,320      | 1,006,720 | 1,358,480 | 1,708,800 |
| Memory (Kb)                  | M20K                 | 36,000       | 42,620    | 48,460    | 54,260    |
|                              | MLAB                 | 5,096        | 5,788     | 9,386     | 12,984    |
| Variable-precision DSP Block |                      | 1,523        | 1,687     | 1,518     | 1,518     |
| 18 x 19 Multiplier           |                      | 3,046        | 3,374     | 3,036     | 3,036     |
| PLL                          | Fractional Synthesis | 16           | 16        | 32        | 32        |
|                              | I/O                  | 16           | 16        | 16        | 16        |
| 17.4 Gbps Transceiver        |                      | 48           | 48        | 96        | 96        |
| GPIO <sup>(3)</sup>          |                      | 696          | 696       | 768       | 768       |
| LVDS Pair <sup>(4)</sup>     |                      | 324          | 324       | 384       | 384       |
| PCIe Hard IP Block           |                      | 2            | 2         | 4         | 4         |
| Hard Memory Controller       |                      | 16           | 16        | 16        | 16        |

## Package Plan

**Table 7. Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | U19<br>(19 mm × 19 mm,<br>484-pin UBGA) |          |      | F27<br>(27 mm × 27 mm,<br>672-pin FBGA) |          |      | F29<br>(29 mm × 29 mm,<br>780-pin FBGA) |          |      |
|--------------|---|----------|------|---|----------|------|---|----------|------|
|              | 3 V I/O                                 | LVDS I/O | XCVR | 3 V I/O                                 | LVDS I/O | XCVR | 3 V I/O                                 | LVDS I/O | XCVR |
| GX 160       | 48                                      | 192      | 6    | 48                                      | 192      | 12   | 48                                      | 240      | 12   |
| GX 220       | 48                                      | 192      | 6    | 48                                      | 192      | 12   | 48                                      | 240      | 12   |
| GX 270       | —                                       | —        | —    | 48                                      | 192      | 12   | 48                                      | 312      | 12   |
| GX 320       | —                                       | —        | —    | 48                                      | 192      | 12   | 48                                      | 312      | 12   |
| GX 480       | —                                       | —        | —    | —                                       | —        | —    | 48                                      | 312      | 12   |



## Maximum Resources

**Table 10. Maximum Resource Counts for Intel Arria 10 GT Devices**

| Resource                     |                      | Product Line      |                   |
|------------------------------|----------------------|-------------------|-------------------|
|                              |                      | GT 900            | GT 1150           |
| Logic Elements (LE) (K)      |                      | 900               | 1,150             |
| ALM                          |                      | 339,620           | 427,200           |
| Register                     |                      | 1,358,480         | 1,708,800         |
| Memory (Kb)                  | M20K                 | 48,460            | 54,260            |
|                              | MLAB                 | 9,386             | 12,984            |
| Variable-precision DSP Block |                      | 1,518             | 1,518             |
| 18 x 19 Multiplier           |                      | 3,036             | 3,036             |
| PLL                          | Fractional Synthesis | 32                | 32                |
|                              | I/O                  | 16                | 16                |
| Transceiver                  | 17.4 Gbps            | 72 <sup>(5)</sup> | 72 <sup>(5)</sup> |
|                              | 25.8 Gbps            | 6                 | 6                 |
| GPIO <sup>(6)</sup>          |                      | 624               | 624               |
| LVDS Pair <sup>(7)</sup>     |                      | 312               | 312               |
| PCIe Hard IP Block           |                      | 4                 | 4                 |
| Hard Memory Controller       |                      | 16                | 16                |

### Related Information

#### Intel Arria 10 GT Channel Usage

Configuring GT/GX channels in Intel Arria 10 GT devices.

## Package Plan

**Table 11. Package Plan for Intel Arria 10 GT Devices**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | SF45<br>(45 mm x 45 mm, 1932-pin FBGA) |          |      |
|--------------|--|----------|------|
|              | 3 V I/O                                | LVDS I/O | XCVR |
| GT 900       | —                                      | 624      | 72   |
| GT 1150      | —                                      | 624      | 72   |

<sup>(5)</sup> If all 6 GT channels are in use, 12 of the GX channels are not usable.

<sup>(6)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(7)</sup> Each LVDS I/O pair can be used as differential input or output.



### Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

## Intel Arria 10 SX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

### Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.

## Available Options

**Figure 3. Sample Ordering Code and Available Options for Intel Arria 10 SX Devices**



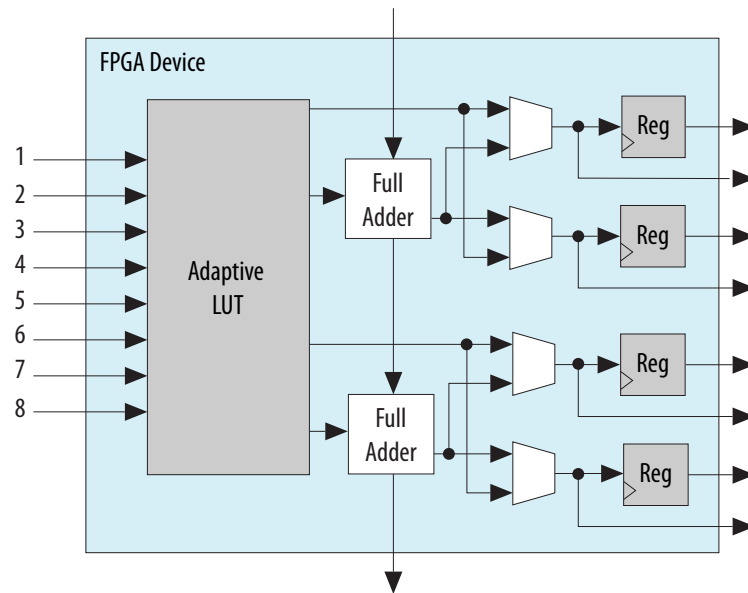
### Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



**Figure 5. ALM for Intel Arria 10 Devices**



The Intel Quartus Prime software optimizes your design according to the ALM logic structure and automatically maps legacy designs into the Intel Arria 10 ALM architecture.

## Variable-Precision DSP Block

The Intel Arria 10 variable precision DSP blocks support fixed-point arithmetic and floating-point arithmetic.

Features for fixed-point arithmetic:

- High-performance, power-optimized, and fully registered multiplication operations
- 18-bit and 27-bit word lengths
- Two 18 x 19 multipliers or one 27 x 27 multiplier per DSP block
- Built-in addition, subtraction, and 64-bit double accumulation register to combine multiplication results
- Cascading 19-bit or 27-bit when pre-adder is disabled and cascading 18-bit when pre-adder is used to form the tap-delay line for filtering applications
- Cascading 64-bit output bus to propagate output results from one block to the next block without external logic support
- Hard pre-adder supported in 19-bit and 27-bit modes for symmetric filters
- Internal coefficient register bank in both 18-bit and 27-bit modes for filter implementation
- 18-bit and 27-bit systolic finite impulse response (FIR) filters with distributed output adder
- Biased rounding support



## Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

## Embedded Memory Capacity in Intel Arria 10 Devices

**Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices**

| Variant           | Product Line | M20K  |              | MLAB   |              | Total RAM Bit (Kb) |
|-------------------|--------------|-------|--------------|--------|--------------|--------------------|
|                   |              | Block | RAM Bit (Kb) | Block  | RAM Bit (Kb) |                    |
| Intel Arria 10 GX | GX 160       | 440   | 8,800        | 1,680  | 1,050        | 9,850              |
|                   | GX 220       | 587   | 11,740       | 2,703  | 1,690        | 13,430             |
|                   | GX 270       | 750   | 15,000       | 3,922  | 2,452        | 17,452             |
|                   | GX 320       | 891   | 17,820       | 4,363  | 2,727        | 20,547             |
|                   | GX 480       | 1,431 | 28,620       | 6,662  | 4,164        | 32,784             |
|                   | GX 570       | 1,800 | 36,000       | 8,153  | 5,096        | 41,096             |
|                   | GX 660       | 2,131 | 42,620       | 9,260  | 5,788        | 48,408             |
|                   | GX 900       | 2,423 | 48,460       | 15,017 | 9,386        | 57,846             |
|                   | GX 1150      | 2,713 | 54,260       | 20,774 | 12,984       | 67,244             |
| Intel Arria 10 GT | GT 900       | 2,423 | 48,460       | 15,017 | 9,386        | 57,846             |
|                   | GT 1150      | 2,713 | 54,260       | 20,774 | 12,984       | 67,244             |
| Intel Arria 10 SX | SX 160       | 440   | 8,800        | 1,680  | 1,050        | 9,850              |
|                   | SX 220       | 587   | 11,740       | 2,703  | 1,690        | 13,430             |
|                   | SX 270       | 750   | 15,000       | 3,922  | 2,452        | 17,452             |
|                   | SX 320       | 891   | 17,820       | 4,363  | 2,727        | 20,547             |
|                   | SX 480       | 1,431 | 28,620       | 6,662  | 4,164        | 32,784             |
|                   | SX 570       | 1,800 | 36,000       | 8,153  | 5,096        | 41,096             |
|                   | SX 660       | 2,131 | 42,620       | 9,260  | 5,788        | 48,408             |



The fractional synthesis PLLs support the following features:

- Reference clock frequency synthesis for transceiver CMU and Advanced Transmit (ATX) PLLs
- Clock network delay compensation
- Zero-delay buffering
- Direct transmit clocking for transceivers
- Independently configurable into two modes:
  - Conventional integer mode equivalent to the general purpose PLL
  - Enhanced fractional mode with third order delta-sigma modulation
- PLL cascading

## I/O PLLs

The integer mode I/O PLLs are located in each bank of 48 I/Os. You can use the I/O PLLs to simplify the design of external memory and high-speed LVDS interfaces.

In each I/O bank, the I/O PLLs are adjacent to the hard memory controllers and LVDS SERDES. Because these PLLs are tightly coupled with the I/Os that need to use them, it makes it easier to close timing.

You can use the I/O PLLs for general purpose applications in the core such as clock network delay compensation and zero-delay buffering.

Intel Arria 10 devices support PLL-to-PLL cascading.

## FPGA General Purpose I/O

Intel Arria 10 devices offer highly configurable GPIOs. Each I/O bank contains 48 general purpose I/Os and a high-efficiency hard memory controller.

The following list describes the features of the GPIOs:

- Consist of 3 V I/Os for high-voltage application and LVDS I/Os for differential signaling
  - Up to two 3 V I/O banks, available in some devices, that support up to 3 V I/O standards
  - LVDS I/O banks that support up to 1.8 V I/O standards
- Support a wide range of single-ended and differential I/O interfaces
- LVDS speeds up to 1.6 Gbps
- Each LVDS pair of pins has differential input and output buffers, allowing you to configure the LVDS direction for each pair.
- Programmable bus hold and weak pull-up
- Programmable differential output voltage ( $V_{OD}$ ) and programmable pre-emphasis

**Table 20. Memory Standards Supported by the Hard Memory Controller**

This table lists the overall capability of the hard memory controller. For specific details, refer to the External Memory Interface Spec Estimator and Intel Arria 10 Device Datasheet.

| Memory Standard | Rate Support | Ping Pong PHY Support | Maximum Frequency (MHz) |
|-----------------|--------------|-----------------------|-------------------------|
| DDR4 SDRAM      | Quarter rate | Yes                   | 1,067                   |
|                 |              | —                     | 1,200                   |
| DDR3 SDRAM      | Half rate    | Yes                   | 533                     |
|                 |              | —                     | 667                     |
|                 | Quarter rate | Yes                   | 1,067                   |
|                 |              | —                     | 1,067                   |
| DDR3L SDRAM     | Half rate    | Yes                   | 533                     |
|                 |              | —                     | 667                     |
|                 | Quarter rate | Yes                   | 933                     |
|                 |              | —                     | 933                     |
| LPDDR3 SDRAM    | Half rate    | —                     | 533                     |
|                 | Quarter rate | —                     | 800                     |

**Table 21. Memory Standards Supported by the Soft Memory Controller**

| Memory Standard             | Rate Support | Maximum Frequency (MHz) |
|-----------------------------|--------------|-------------------------|
| RLDRAM 3 <sup>(11)</sup>    | Quarter rate | 1,200                   |
| QDR IV SRAM <sup>(11)</sup> | Quarter rate | 1,067                   |
| QDR II SRAM                 | Full rate    | 333                     |
|                             | Half rate    | 633                     |
| QDR II+ SRAM                | Full rate    | 333                     |
|                             | Half rate    | 633                     |
| QDR II+ Xtreme SRAM         | Full rate    | 333                     |
|                             | Half rate    | 633                     |

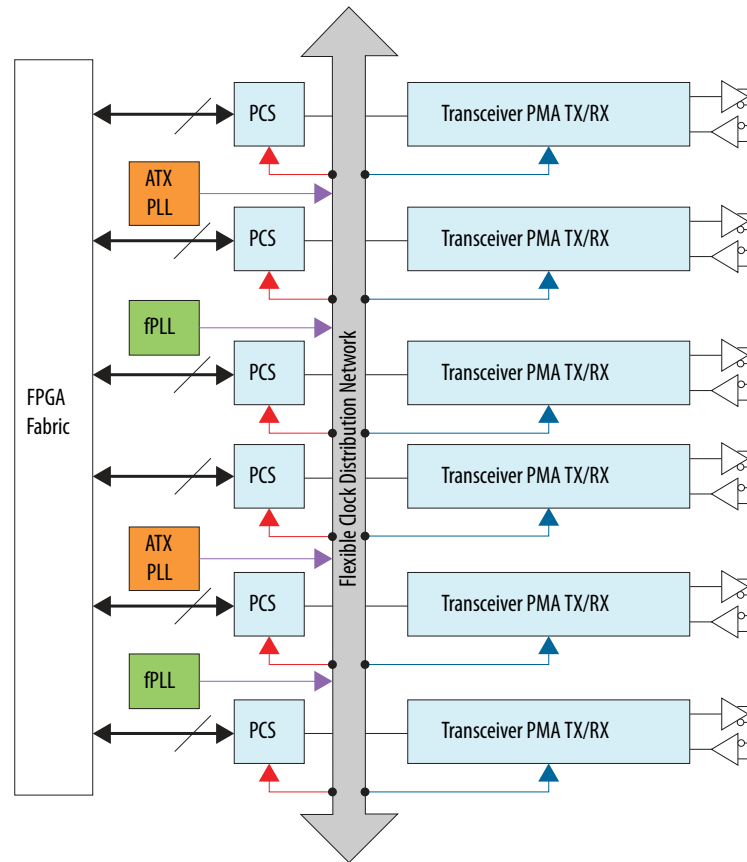
**Table 22. Memory Standards Supported by the HPS Hard Memory Controller**

The hard processor system (HPS) is available in Intel Arria 10 SoC devices only.

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------|--------------|-------------------------|
| DDR4 SDRAM      | Half rate    | 1,200                   |
| DDR3 SDRAM      | Half rate    | 1,067                   |
| DDR3L SDRAM     | Half rate    | 933                     |

<sup>(11)</sup> Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.

**Figure 6. Intel Arria 10 Transceiver Block Architecture**



## Transceiver Channels

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other pre-processing functions before transferring data to the FPGA core fabric.

A transceiver channel consists of a PMA and a PCS block. Most transceiver banks have 6 channels. There are some transceiver banks that contain only 3 channels.

A wide variety of bonded and non-bonded data rate configurations is possible using a highly configurable clock distribution network. Up to 80 independent transceiver data rates can be configured.

The following figures are graphical representations of top views of the silicon die, which correspond to reverse views for flip chip packages. Different Intel Arria 10 devices may have different floorplans than the ones shown in the figures.



Each transceiver channel contains a channel PLL that can be used as the CMU PLL or clock data recovery (CDR) PLL. In CDR mode, the channel PLL recovers the receiver clock and data in the transceiver channel. Up to 80 independent data rates can be configured on a single Intel Arria 10 device.

**Table 23. PMA Features of the Transceivers in Intel Arria 10 Devices**

| Feature   | Capability   |
|---|--|
| Chip-to-Chip Data Rates                                 | 1 Gbps to 17.4 Gbps (Intel Arria 10 GX devices)<br>1 Gbps to 25.8 Gbps (Intel Arria 10 GT devices)   |
| Backplane Support                                       | Drive backplanes at data rates up to 12.5 Gbps   |
| Optical Module Support                                  | SFP+/SFP, XFP, CXP, QSFP/QSFP28, CFP/CFP2/CFP4   |
| Cable Driving Support                                   | SFP+ Direct Attach, PCI Express over cable, eSATA  |
| Transmit Pre-Emphasis                                   | 4-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss  |
| Continuous Time Linear Equalizer (CTLE)                 | Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss  |
| Decision Feedback Equalizer (DFE)                       | 7-fixed and 4-floating tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments  |
| Variable Gain Amplifier                                 | Optimizes the signal amplitude prior to the CDR sampling and operates in fixed and adaptive modes  |
| Altera Digital Adaptive Parametric Tuning (ADAPT)       | Fully digital adaptation engine to automatically adjust all link equalization parameters—including CTLE, DFE, and variable gain amplifier blocks—that provide optimal link margin without intervention from user logic |
| Precision Signal Integrity Calibration Engine (PreSICE) | Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance  |
| Advanced Transmit (ATX) PLL                             | Low jitter ATX (LC tank based) PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols   |
| Fractional PLLs   | On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost   |
| Digitally Assisted Analog CDR                           | Superior jitter tolerance with fast lock time  |
| Dynamic Partial Reconfiguration                         | Allows independent control of the Avalon memory-mapped interface of each transceiver channel for the highest transceiver flexibility   |
| Multiple PCS-PMA and PCS-PLD interface widths           | 8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency  |

## PCS Features

This table summarizes the Intel Arria 10 transceiver PCS features. You can use the transceiver PCS to support a wide range of protocols ranging from 1 Gbps to 25.8 Gbps.



| Protocol             | Data Rate (Gbps)              | Transceiver IP | PCS Support  |
|----------------------|-------------------------------|----------------|--------------|
| CPRI 6.0 (64B/66B)   | 0.6144 to 10.1376             | Native PHY     | Enhanced PCS |
| CPRI 4.2 (8B/10B)    | 0.6144 to 9.8304              | Native PHY     | Standard PCS |
| OBSAI RP3 v4.2       | 0.6144 to 6.144               | Native PHY     | Standard PCS |
| SD-SDI/HD-SDI/3G-SDI | 0.143 <sup>(12)</sup> to 2.97 | Native PHY     | Standard PCS |

### Related Information

#### [Intel Arria 10 Transceiver PHY User Guide](#)

Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

## SoC with Hard Processor System

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

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<sup>(12)</sup> The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.



**Table 24. Improvements in 20 nm HPS**

This table lists the key improvements of the 20 nm HPS compared to the 28 nm HPS.

| Advantages/<br>Improvements                           | Description   |
|---|---|
| Increased performance and overdrive capability        | While the nominal processor frequency is 1.2 GHz, the 20 nm HPS offers an “overdrive” feature which enables a higher processor operating frequency. This requires a higher supply voltage value that is unique to the HPS and may require a separate regulator.   |
| Increased processor memory bandwidth and DDR4 support | Up to 64-bit DDR4 memory at 2,400 Mbps support is available for the processor. The hard memory controller for the HPS comprises a multi-port front end that manages connections to a single port memory controller. The multi-port front end allows logic core and the HPS to share ports and thereby the available bandwidth of the memory controller.   |
| Flexible I/O sharing                                  | An advanced I/O pin muxing scheme allows improved sharing of I/O between the HPS and the core logic. The following types of I/O are available for SoC: <ul style="list-style-type: none"><li>• 17 dedicated I/Os—physically located inside the HPS block and are not accessible to logic within the core. The 17 dedicated I/Os are used for HPS clock, resets, and interfacing with boot devices, QSPI, and SD/MMC.</li><li>• 48 direct shared I/O—located closest to the HPS block and are ideal for high speed HPS peripherals such as EMAC, USB, and others. There is one bank of 48 I/Os that supports direct sharing where the 48 I/Os can be shared 12 I/Os at a time.</li><li>• Standard (shared) I/O—all standard I/Os can be shared by the HPS peripherals and any logic within the core. For designs where more than 48 I/Os are required to fully use all the peripherals in the HPS, these I/Os can be connected through the core logic.</li></ul> |
| EMAC core   | Three EMAC cores are available in the HPS. The EMAC cores enable an application to support two redundant Ethernet connections; for example, backplane, or two EMAC cores for managing IEEE 1588 time stamp information while allowing a third EMAC core for debug and configuration. All three EMACs can potentially share the same time stamps, simplifying the 1588 time stamping implementation. A new serial time stamp interface allows core logic to access and read the time stamp values. The integrated EMAC controllers can be connected to external Ethernet PHY through the provided MDIO or I <sup>2</sup> C interface.  |
| On-chip memory  | The on-chip memory is updated to 256 KB support and can support larger data sets and real time algorithms.  |
| ECC enhancements                                      | Improvements in L2 Cache ECC management allow identification of errors down to the address level. ECC enhancements also enable improved error injection and status reporting via the introduction of new memory mapped access to syndrome and data signals.   |
| HPS to FPGA Interconnect Backbone                     | Although the HPS and the Logic Core can operate independently, they are tightly coupled via a high-bandwidth system interconnect built from high-performance ARM AMBA AXI bus bridges. IP bus masters in the FPGA fabric have access to HPS bus slaves via the FPGA-to-HPS interconnect. Similarly, HPS bus masters have access to bus slaves in the core fabric via the HPS-to-FPGA bridge. Both bridges are AMBA AXI-3 compliant and support simultaneous read and write transactions. Up to three masters within the core fabric can share the HPS SDRAM controller with the processor. Additionally, the processor can be used to configure the core fabric under program control via a dedicated 32-bit configuration port.  |
| FPGA configuration and HPS booting                    | The FPGA fabric and HPS in the SoCs are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.<br>You can configure the FPGA fabric and boot the HPS independently, in any order, providing you with more design flexibility.  |
| Security  | New security features have been introduced for anti-tamper management, secure boot, encryption (AES), and authentication (SHA).   |



## System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

## HPS-FPGA AXI Bridges

The HPS-FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI™) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS-FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

## HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



## FPGA Configuration and HPS Booting

The FPGA fabric and HPS in the SoC FPGA must be powered at the same time. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.

Once powered, the FPGA fabric and HPS can be configured independently thus providing you with more design flexibility:

- You can boot the HPS independently. After the HPS is running, the HPS can fully or partially reconfigure the FPGA fabric at any time under software control. The HPS can also configure other FPGAs on the board through the FPGA configuration controller.
- Configure the FPGA fabric first, and then boot the HPS from memory accessible to the FPGA fabric.

## Hardware and Software Development

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer system integration tool in the Intel Quartus Prime software.

For software development, the ARM-based SoC FPGA devices inherit the rich software development ecosystem available for the ARM Cortex-A9 MPCore processor. The software development process for Intel SoC FPGAs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux\*, VxWorks\*, and other operating systems are available for the SoC FPGAs. For more information on the operating systems support availability, contact the Intel FPGA sales team.

You can begin device-specific firmware and software development on the Intel SoC FPGA Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

## Dynamic and Partial Reconfiguration

The Intel Arria 10 devices support dynamic and partial reconfiguration. You can use dynamic and partial reconfiguration simultaneously to enable seamless reconfiguration of both the device core and transceivers.

### Dynamic Reconfiguration

You can reconfigure the PMA and PCS blocks while the device continues to operate. This feature allows you to change the data rates, protocol, and analog settings of a channel in a transceiver bank without affecting on-going data transfer in other transceiver banks. This feature is ideal for applications that require dynamic multiprotocol or multirate support.

### Partial Reconfiguration

Using partial reconfiguration, you can reconfigure some parts of the device while keeping the device in operation.



Instead of placing all device functions in the FPGA fabric, you can store some functions that do not run simultaneously in external memory and load them only when required. This capability increases the effective logic density of the device, and lowers cost and power consumption.

In the Intel solution, you do not have to worry about intricate device architecture to perform a partial reconfiguration. The partial reconfiguration capability is built into the Intel Quartus Prime design software, making such time-intensive task simple.

Intel Arria 10 devices support partial reconfiguration in the following configuration options:

- Using an internal host:
  - All supported configuration modes where the FPGA has access to external memory devices such as serial and parallel flash memory.
  - Configuration via Protocol [CvP (PCIe)]
- Using an external host—passive serial (PS), fast passive parallel (FPP) x8, FPP x16, and FPP x32 I/O interface.

## Enhanced Configuration and Configuration via Protocol

**Table 25. Configuration Schemes and Features of Intel Arria 10 Devices**

Intel Arria 10 devices support 1.8 V programming voltage and several configuration schemes.

| Scheme   | Data Width    | Max Clock Rate (MHz) | Max Data Rate (Mbps) <sup>(13)</sup> | Decompression | Design Security <sup>(14)</sup> | Partial Reconfiguration <sup>(15)</sup> | Remote System Update                |
|--|---------------|----------------------|--------------------------------------|---------------|---------------------------------|---|-------------------------------------|
| JTAG   | 1 bit         | 33                   | 33                                   | —             | —                               | Yes <sup>(16)</sup>                     | —                                   |
| Active Serial (AS) through the EPCQ-L configuration device   | 1 bit, 4 bits | 100                  | 400                                  | Yes           | Yes                             | Yes <sup>(16)</sup>                     | Yes                                 |
| Passive serial (PS) through CPLD or external microcontroller | 1 bit         | 100                  | 100                                  | Yes           | Yes                             | Yes <sup>(16)</sup>                     | Parallel Flash Loader (PFL) IP core |

*continued...*

<sup>(13)</sup> Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

<sup>(14)</sup> Encryption and compression cannot be used simultaneously.

<sup>(15)</sup> Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

<sup>(16)</sup> Partial configuration can be performed only when it is configured as internal host.



| Date           | Version    | Changes  |
|----------------|------------|--|
|                |            | <ul style="list-style-type: none"> <li>Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from <i>Sample Ordering Core and Available Options for Intel Arria 10 GT Devices</i> figure.</li> <li>Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps.</li> <li>Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from <i>PMA Features of the Transceivers in Intel Arria 10 Devices</i> table.</li> </ul>   |
| September 2017 | 2017.09.20 | Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.   |
| July 2017      | 2017.07.13 | Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".  |
| July 2017      | 2017.07.06 | Added automotive temperature option to Intel Arria 10 GX device family.  |
| May 2017       | 2017.05.08 | <ul style="list-style-type: none"> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants.</li> <li>Removed all "Preliminary" marks.</li> </ul>   |
| March 2017     | 2017.03.15 | <ul style="list-style-type: none"> <li>Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices.</li> <li>Rebranded as Intel.</li> </ul>  |
| October 2016   | 2016.10.31 | <ul style="list-style-type: none"> <li>Removed package F36 from Intel Arria 10 GX devices.</li> <li>Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers.</li> </ul>   |
| May 2016       | 2016.05.02 | <ul style="list-style-type: none"> <li>Updated the FPGA Configuration and HPS Booting topic.</li> <li>Remove V<sub>CC</sub> PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices.</li> <li>Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA.</li> <li>Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices.</li> </ul>   |
| February 2016  | 2016.02.11 | <ul style="list-style-type: none"> <li>Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally.</li> <li>Revised the state for Core clock networks in the Summary of Features topic.</li> <li>Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table.</li> <li>Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table.</li> <li>Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table.</li> <li>Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure.</li> <li>Changed transceiver parameters in the "Low Power Serial Transceivers" section.</li> <li>Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table.</li> <li>Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure.</li> <li>Changed the datarates for GT devices in the "PMA Features" section.</li> <li>Changed the datarates for GT devices in the "PCS Features" section.</li> </ul> |
| continued...   |            |  |



| Date          | Version    | Changes  |
|---------------|------------|--|
| August 2014   | 2014.08.18 | <ul style="list-style-type: none"> <li>Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620.</li> <li>Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table.</li> <li>Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration.</li> <li>Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller.</li> <li>Added variable precision DSP blocks support for floating-point arithmetic.</li> </ul> |
| June 2014     | 2014.06.19 | Updated number of dedicated I/Os in the HPS block to 17.   |
| February 2014 | 2014.02.21 | Updated transceiver speed grade options for GT devices in Figure 2.  |
| February 2014 | 2014.02.06 | Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps.   |
| December 2013 | 2013.12.10 | <ul style="list-style-type: none"> <li>Updated the HPS memory standards support from LPDDR2 to LPDDR3.</li> <li>Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks .</li> </ul>   |
| December 2013 | 2013.12.02 | Initial release.   |